



Solid State Devices, Inc.

14701 Firestone Blvd * La Mirada, Ca 90638
 Phone: (562) 404-4474 * Fax: (562) 404-1773
 ssdi@ssdi-power.com * www.ssdi-power.com

SFF116N10M SFF116N10Z

116 AMP , 100 Volts, 15 mΩ Avalanche Rated N-channel MOSFET

DESIGNER'S DATA SHEET

Part Number / Ordering Information ^{1/}
SFF116N10

— = Not Screened
 TX = TX Level
 TXV = TXV Level
 S = S Level

— = Straight Leads
 DB = Down Bend
 UB = Up Bend

M = TO-254
 Z = TO-254Z

Screening ^{2/}

Lead Option ^{3/}

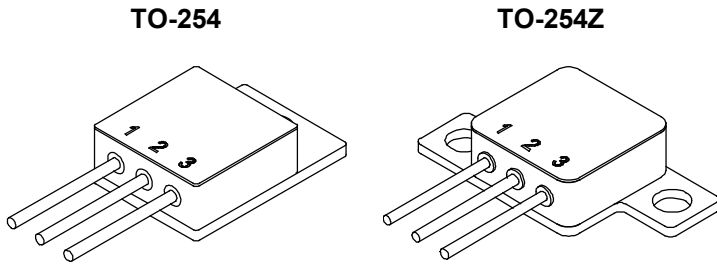
Package ^{3/ 4/}

- Features:**
- Rugged poly-Si gate
 - Lowest ON-resistance in the industry
 - Avalanche rated
 - Hermetically Sealed, Isolated Package
 - Low Total Gate Charge
 - Fast Switching
 - TX, TXV, S-Level screening available
 - Improved ($R_{DS(ON)}$ Q_G) figure of merit

| Maximum Ratings | | Symbol | Value | Units |
|---|-------------------------|----------------------|----------------------|----------------|
| Drain - Source Voltage | | V_{DSS} | 100 | V |
| Gate – Source Voltage | continuous transient | V_{GS} | ± 20 ± 30 | V |
| Max. Continuous Drain Current (package limited) | @ $T_C = 25^\circ C$ | I_{D1} | 55 | A |
| Max. Instantaneous Drain Current (Tj limited) | @ $T_C = 25^\circ C$ | I_{D2} | 116 | A |
| | @ $T_C = 175^\circ C$ | I_{D3} | 80 | A |
| Max. Avalanche current | @ L= 0.1 mH | I_{AR} | 60 | A |
| Single and Repetitive Avalanche Energy | @ L= 0.1 mH | E_{AS} | 2500 | mJ |
| | | E_{AR} | 80 | |
| Total Power Dissipation | @ $T_C = 25^\circ C$ | P_D | 150 | W |
| Operating & Storage Temperature | | T_{OP} & T_{STG} | -55 to +175 | $^\circ C$ |
| Maximum Thermal Resistance (Junction to Case) | | $R_{\theta JC}$ | 1.0 (typ.0.75) | $^\circ C / W$ |

NOTES:

- *Pulse Test: Pulse Width = 300μsec, Duty Cycle = 2%.
- 1/ For ordering information, price, and availability - contact factory.
- 2/ Screening based on MIL-PRF-19500. Screening flows available on request.
- 3/ For package outlines / lead bending options / pinout configurations - contact factory.
- 4/ Maximum current limited by package configuration
- 5/ Unless otherwise specified, all electrical characteristics @25°C.





Solid State Devices, Inc.

14701 Firestone Blvd * La Mirada, Ca 90638
 Phone: (562) 404-4474 * Fax: (562) 404-1773
 ssdi@ssdi-power.com * www.ssdi-power.com

SFF116N10M

SFF116N10Z

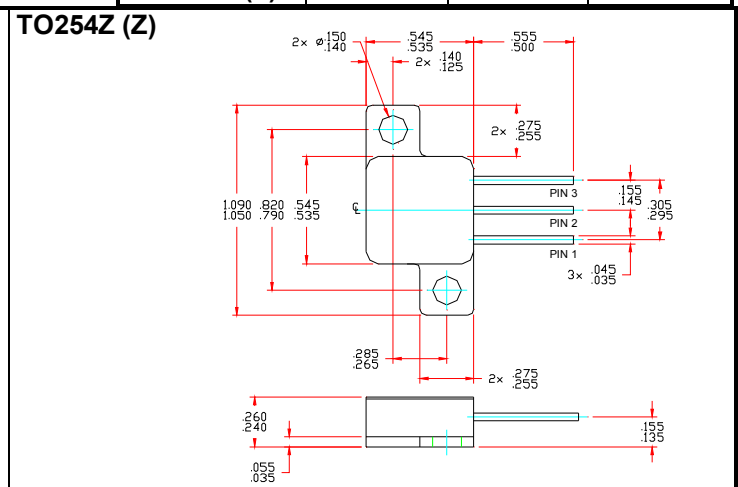
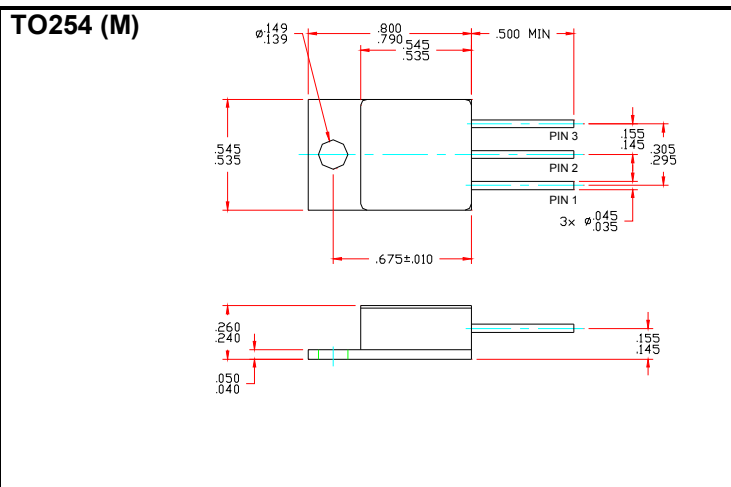
| Electrical Characteristics ^{5/} | Symbol | Min | Typ | Max | Units |
|--|--------------|-----------------|-------------------|----------------|-------------------------------|
| Drain to Source Breakdown Voltage $V_{GS} = 0V, I_D = 250\mu A$ | BV_{DSS} | 100 | 110 | — | V |
| Drain to Source On State Resistance $V_{GS} = 10V, I_D = 50A, T_j = 25^\circ C$ $V_{GS} = 10V, I_D = 50A, T_j = 125^\circ C$ $V_{GS} = 10V, I_D = 50A, T_j = 150^\circ C$ | $R_{DS(on)}$ | — — — | 10 16 20 | 15 25 — | m Ω |
| Gate Threshold Voltage $V_{DS} = V_{GS}, I_D = 1.0mA, T_j = 25^\circ C$ $V_{DS} = V_{GS}, I_D = 1.0mA, T_j = 125^\circ C$ $V_{DS} = V_{GS}, I_D = 1.0mA, T_j = -55^\circ C$ | $V_{GS(th)}$ | 3.0 2.0 — | 4.5 3.5 5.0 | 5.0 — 6 | V |
| Gate to Source Leakage $V_{GS} = \pm 20V, T_j = 25^\circ C$ $V_{GS} = \pm 20V, T_j = 125^\circ C$ | I_{GSS} | — — | 10 30 | ± 100 — | nA |
| Zero Gate Voltage Drain Current $V_{DS} = 100V, V_{GS} = 0V, T_j = 25^\circ C$ $V_{DS} = 100V, V_{GS} = 0V, T_j = 125^\circ C$ $V_{DS} = 100V, V_{GS} = 0V, T_j = 175^\circ C$ | I_{DSS} | — — — | 0.01 2.5 25 | 25 250 — | μA μA μA |
| Forward Transconductance $V_{DS} = 15V, I_D = 35A, T_j = 25^\circ C$ | g_{fs} | 10 | 60 | — | Mho |
| Total Gate Charge $V_{GS} = 12V$ | Q_g | — | 125 | 250 | nC |
| Gate to Source Charge $V_{DS} = 35V$ | Q_{gs} | — | 35 | 75 | nC |
| Gate to Drain Charge $I_D = 50A$ | Q_{gd} | — | 65 | 120 | nC |
| Turn on Delay Time $V_{GS} = 11V$ | $t_{d(on)}$ | — | 39 | 50 | nsec |
| Rise Time $V_{DS} = 50V$ | t_r | — | 67 | 80 | |
| Turn off Delay Time $I_D = 35A$ | $t_{d(off)}$ | — | 80 | 100 | |
| Fall Time $R_G = 2.35\Omega, pw = 3\mu s$ | t_f | — | 67 | 80 | |
| Diode Forward Voltage $I_F = 35A, V_{GS} = 0V$ | V_{SD} | — | 0.82 | 1.2 | V |
| Diode Reverse Recovery Time $I_F = 50A, di/dt = 100A/\mu sec$ | t_{rr} | — | 240 | 300 | nsec |
| Reverse Recovery Charge | Q_{rr} | — | 0.85 | — | μC |
| Input Capacitance $V_{GS} = 0V$ | C_{iss} | — | 4800 | — | pF |
| Output Capacitance $V_{DS} = 25V$ | C_{oss} | — | 2050 | — | |
| Reverse Transfer Capacitance $f = 1 MHz$ | C_{rss} | — | 600 | — | |

Available Part Numbers:

Consult Factory

PIN ASSIGNMENT (Standard)

| Package | Drain | Source | Gate |
|-------------|-------|--------|-------|
| TO-254 (M) | Pin 1 | Pin 2 | Pin 3 |
| TO-254Z (Z) | Pin 1 | Pin 2 | Pin 3 |



NOTE: All specifications are subject to change without notification. SCD's for these devices should be reviewed by SSDI prior to release.

DATA SHEET #: FT0037B

DOC